



«X-Technologies/X-Concepts»

Key Enablers of Further Performance Improvements in Power Electronics



Johann W. Kolar, et al. Swiss Federal Institute of Technology (ETH) Zurich Power Electronic Systems Laboratory www.pes.ee.ethz.ch



100th IFX Tech Talk April 5, 2024







«X-Technologies/X-Concepts»

Key Enablers of Further Performance Improvements in Power Electronics

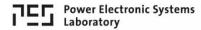


Johann W. Kolar & Jonas Huber Swiss Federal Institute of Technology (ETH) Zurich Power Electronic Systems Laboratory www.pes.ee.ethz.ch



100th IFX Tech Talk April 5, 2024







"X-Technologies / X-Concepts" – Key Enablers of Further Performance Improvements in Power Electronics

Abstract— Power electronics is a key technology for all forms of electrical energy generation and use in modern society, ranging from renewable energy systems and very diverse power supply applications, including fast charging of electric vehicles and hyper-scale data centers, to variable frequency motor drives for industrial automation. Progress in this area has been driven over the last 40 years by new concepts for power semiconductors and corresponding circuit topologies and modulation/control schemes, as well as the introduction of integrated circuits and microprocessors enabling digital signal processing and control.

We are now in the midst of another highly dynamic phase of development in power electronics, and it is interesting to reflect on the driving forces, in other words, to identify the "x-technologies" and "x-concepts" that will shape the field in the next decade. After a brief review of x-technology candidates such as monolithic bidirectional GaN switches, 3D-packaging and ML-supported multi-objective design optimization, the talk identifies key x-concepts, namely modularization, hybridization, synergetic association, functional integration and decentralization, and then demonstrates/verifies their capabilities using latest research results from the Power Electronic Systems Laboratory at ETH Zurich, like a 99.4% efficient multi-level PV inverter system, an ultra-compact 3-port automotive DC/DC converter system, a synergetically controlled ultra-wide output voltage range three-phase EV charger, a monolithic bidirectional GaN switch current DC-link AC/AC converter for motor integrated variable speed drives, a 4.8MHz switching frequency 100kHz bandwidth AC-source and a partial power processing DC/DC server power supply.

Finally, the urgency of transitioning from today's linear economy to a circular economy and/or of life cycle assessments, embodied energy analyses and design for repair, reuse and recyclability are highlighted as important "beyond tomorrow" topics for power electronics research to ensure that the widely accepted net-zero CO₂ target for 2050 is ultimately achieved on a sustainable basis.







Acknowledgement

45 min **Outline**

► Introduction

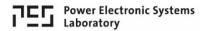
Conclusions

X-Technologies
 X-Concepts

M. Antivachis J. Azurza J. Biela D. Bortis H. Ertl T. Guillod M. Haider L. Imperiali M. Kasper J. Kaufmann G. Knabben F. Krismer Y. Li D. Menzi S. Miric J. Miniböck N. Nain D. Naumayr P. Niklaus J. Schäfer L. Schrittwieser F. Vollmaier St. Waffler S. Weihe D. Zhang







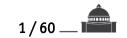


Introduction

Clean Energy Transition All-Electric Society

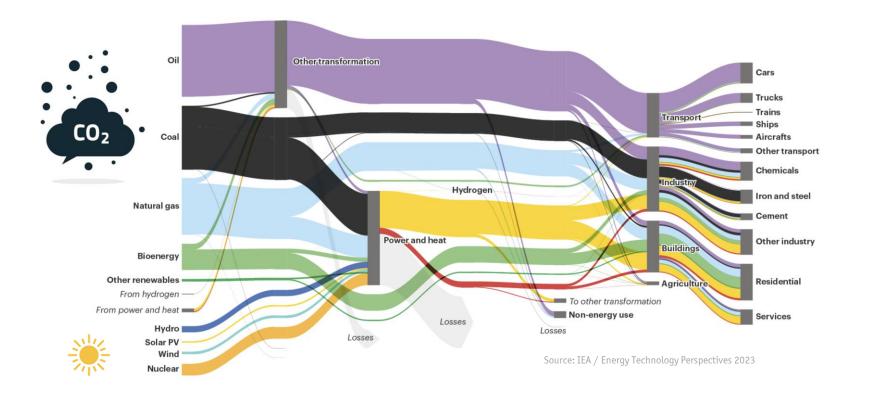






The Challenge

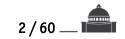
■ Global Energy Flows — 2021



• Large Share of Fossil Fuels (!)

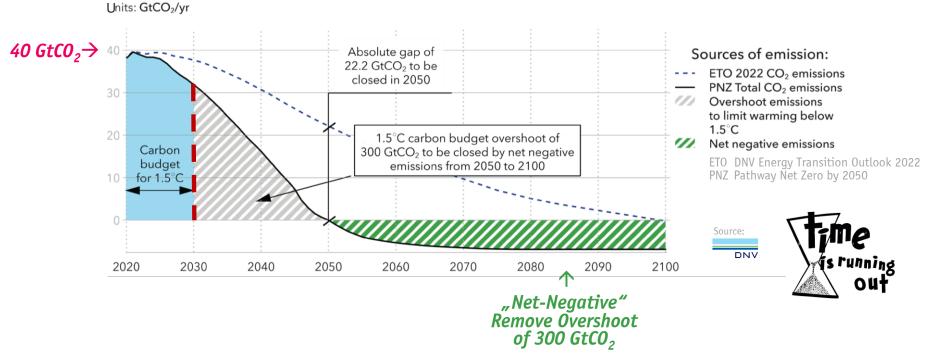






Decarbonization / Defossilization

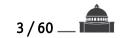
■ "Net-Zero" Emissions by 2050 & Gap to be Closed ■ 50 GtCO_{2eq} Global Greenhouse Gas Emissions / Year → 280 GtCO₂ Budget Left for 1.5°C Limit



- Challenge of Stepping Back from Oil & Gas
- Human History Transition from Lower to Higher Energy Density Fuel Wood \rightarrow Coal \rightarrow Oil & Gas

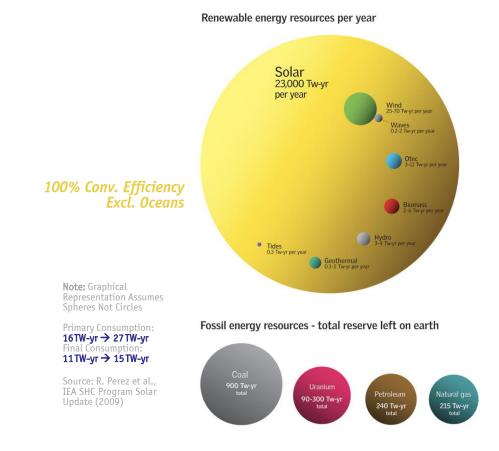




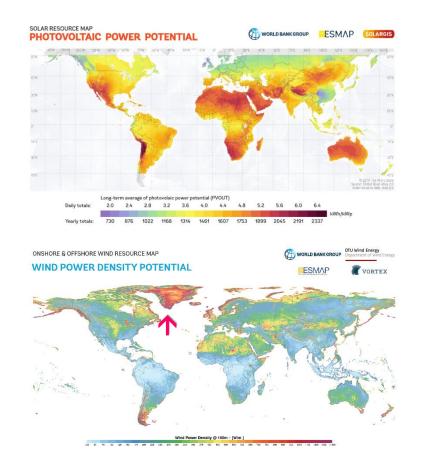


The Opportunity

(2009) 16 TW-yr — 16 TW-yr (2050)



Global Distribution of Solar & Wind Resources

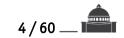






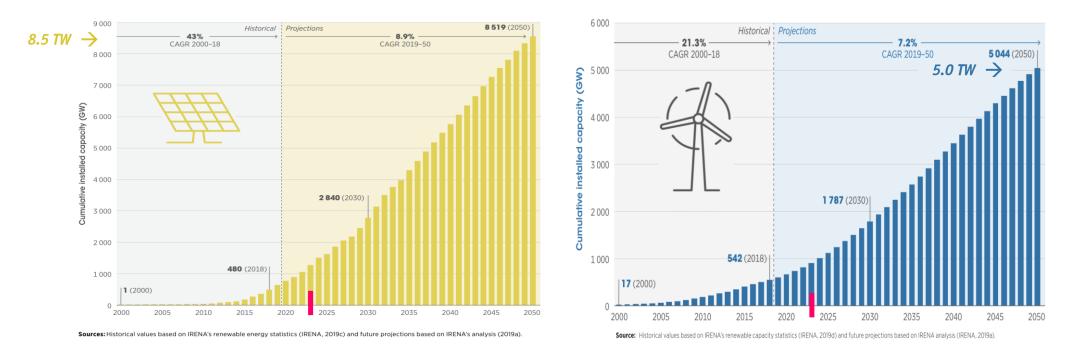


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The Approach

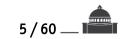
Outlook of Global Cumulative Installations Until 2050 / Add. 1000 GW Off-Shore Wind Power
 In 2050 Deployment of 370 GW/Year (PV) & 200 GW/Year (On-Shore Wind) incl. Replacements



• CAGR of \approx 9% up to 2050 \rightarrow 8500 GW

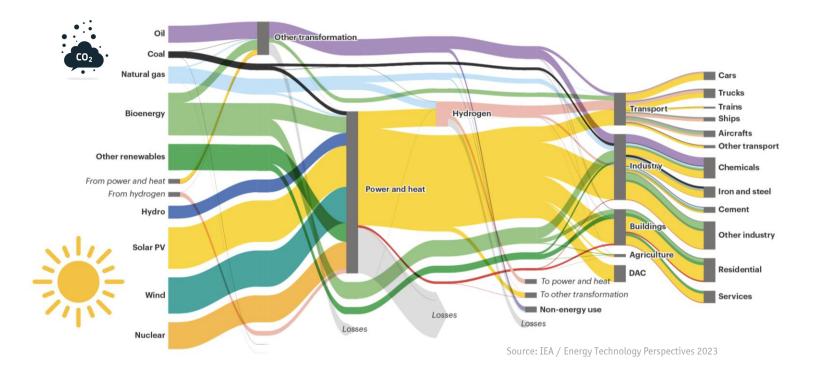
• CAGR of \approx 7% up to 2050 \rightarrow 5000 GW





Net-Zero CO₂ by 2050

■ Global Energy Flows — 2050 / Net-Zero Scenario



Dominant Share of Electric Energy — Power Electronics as Key Technology (!)

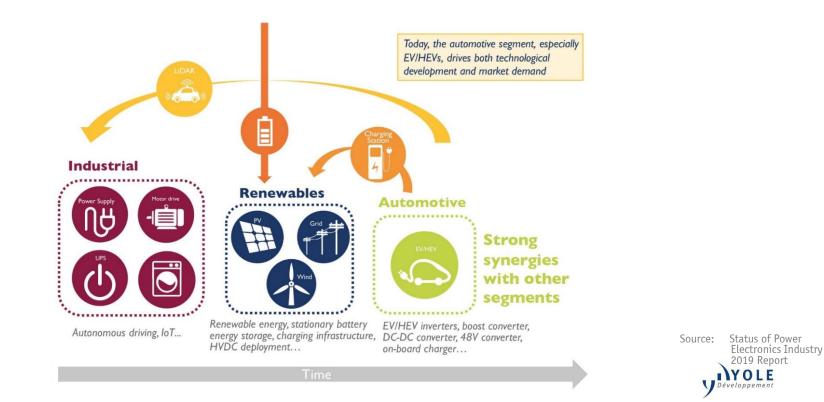






Fundamental Role of Power Electronics

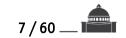
■ Global MEGA-Trends → Industry Automation | Renewable Energy | Sustainable Mobility | Urbanization etc.



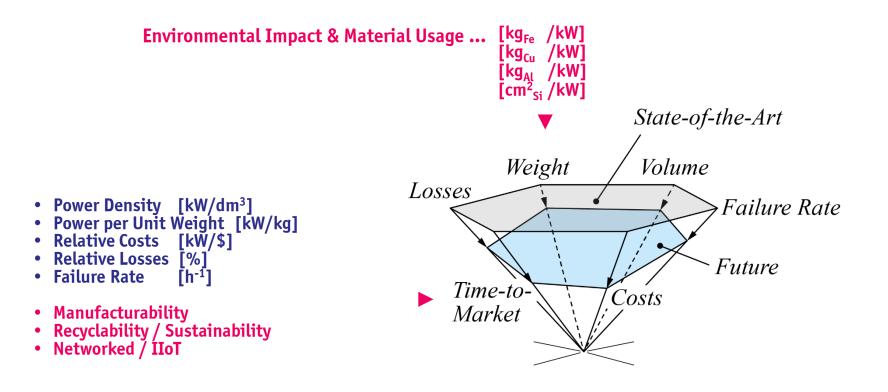
- Clean Energy Transition \rightarrow "All-Electric" Society
- UN Sustainable Development Agenda \rightarrow There can be No "Plan B", because there is No "Planet B" (Ban Ki-moon)







Performance Indicators / Trends



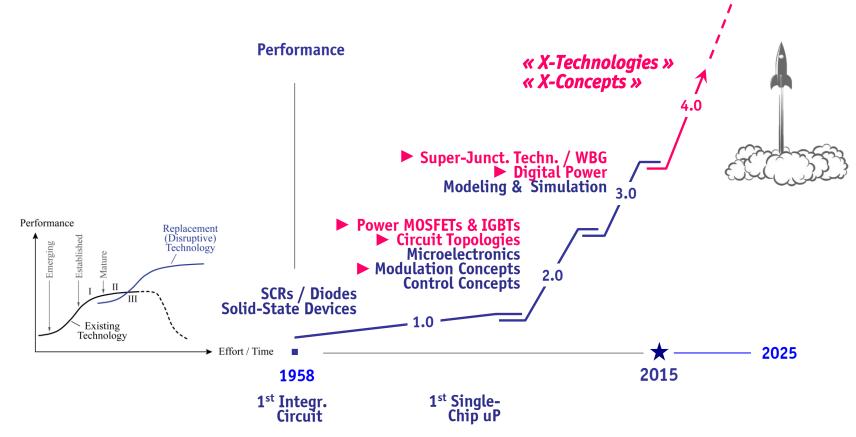


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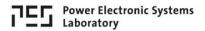
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S-Curve of Power Electronics

- « X-Technologies » / "Moon-Shot" Technologies
 « X-Concepts » → Full Utilization of Basic Scaling Laws & « X-Technologies »
- Power Electronics $1.0 \rightarrow$ Power Electronics 4.0
- 2...5...10x Improvement NOT Only 10% !







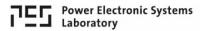


X-Technologies

SiC | GaN —— 3D-Packaging & Integration Digital Signal Processing





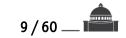




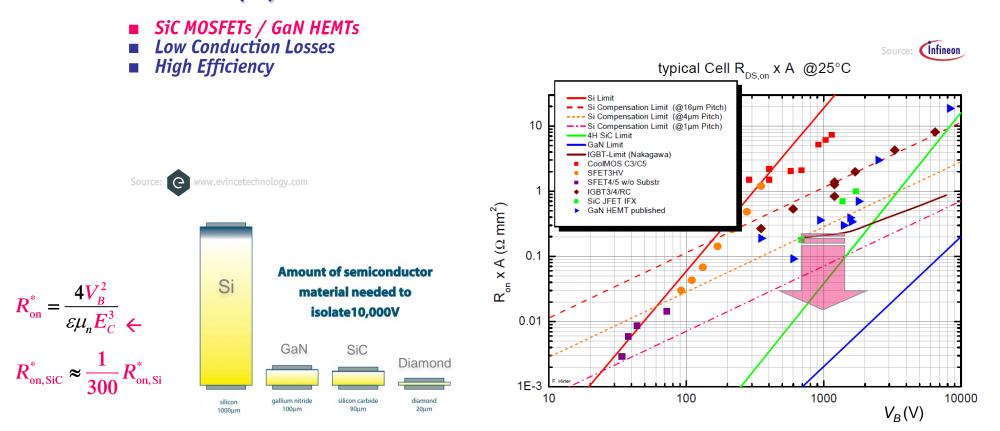








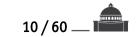
Low R^{*}_{DS(on)} High-Voltage Devices



■ High Voltage Unipolar (!) Devices → Excellent Sw. Performance / High Power Density

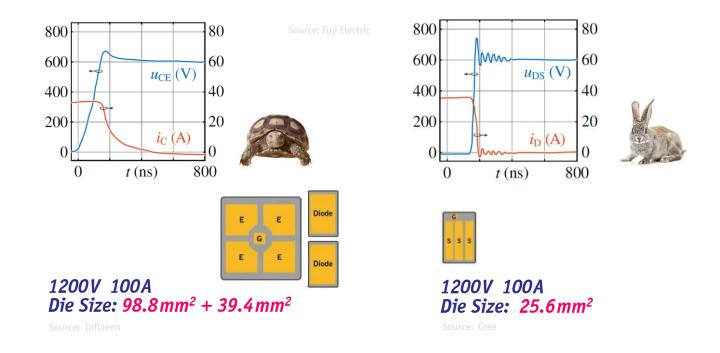






Si vs. SiC Switching Behavior

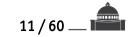
- Si-IGBT \rightarrow Const. On-State Voltage Drop / Rel. Low Switching Speed, SiC-MOSFETs \rightarrow Resistive On-State Behavior / Factor 10 Higher Sw. Speed



Extremely High di/dt & dv/dt \rightarrow Challenges in Packaging / EMI

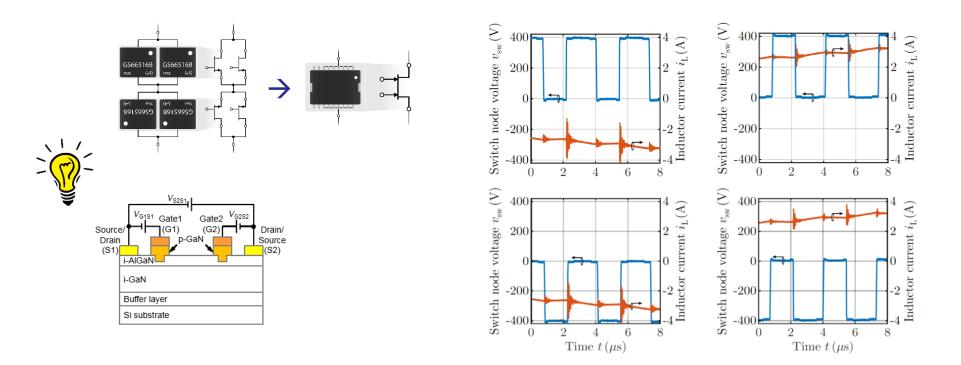






Monolithic 600V GaN Bidirectional/Bipolar Switch

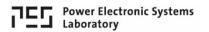
- POWER AMERICA Program Based on Infineon's CoolGaN™ HEMT Technology (infineon Dual-Gate Device / Controllability of Both Current Directions Bipolar Voltage Blocking Capability | Normally-On or -Off



• Analysis of 4-Quardant Operation of $R_{DS(on)} = 140m\Omega \mid 600V$ Sample @ $\pm 400V$







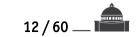






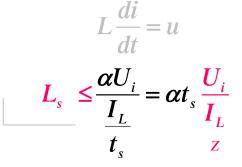


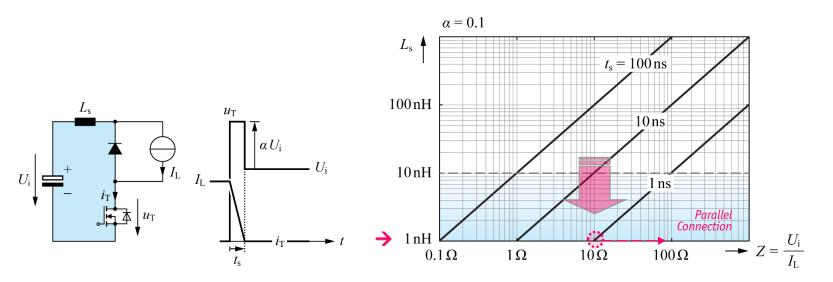
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Circuit Parasitics

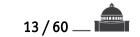
- Extremely High di/dt Commutation Loop Inductance L_s
- Allowed L, Directly Related to Switching Time $t_s \rightarrow$





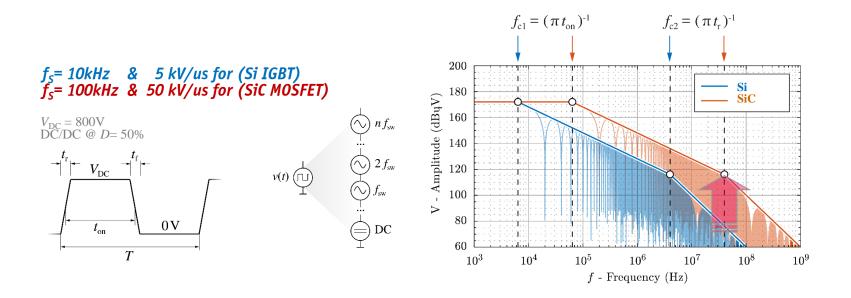
• Advanced Packaging & Parallel Interleaving for Partitioning of Large Currents





Si vs. SiC EMI Emissions

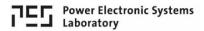
- Higher dv/dt → Factor 1
 Higher Switching Frequencies → Factor 1
 EMI Envelope Shifted to Higher Frequencies \rightarrow Factor 10
- \rightarrow Factor 10



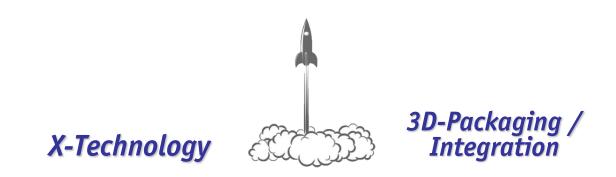
• Higher Influence of Filter Component Parasitics & Couplings \rightarrow Advanced Design





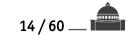










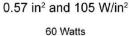


3D-Packaging / Heterogeneous Integration

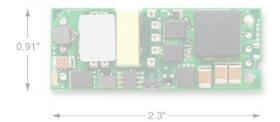
- System in Package (SiP) Approach Minim. of Parasitic Inductances / EMI Shielding / Integr. Thermal Management Very High Power Density (No Bond Wires / Solder / Thermal Paste)
- PCBs Embedded Optic Fibres
- Automated Manufacturing
- Recycling (?)

2.1 in² and 34 W/in²

72 Watts



0.87



0.97

1.26 in² and 26 W/in² 33 Watts

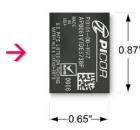
1.3"

0.57 in² and 105 W/in²

 \rightarrow

60 Watts

←0.65"->

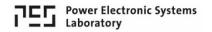


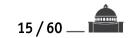




- Future Application Up to 100kW (!)
- New Design Tools & Measurement Systems (!)
- University / Industry Technology Partnership (!)

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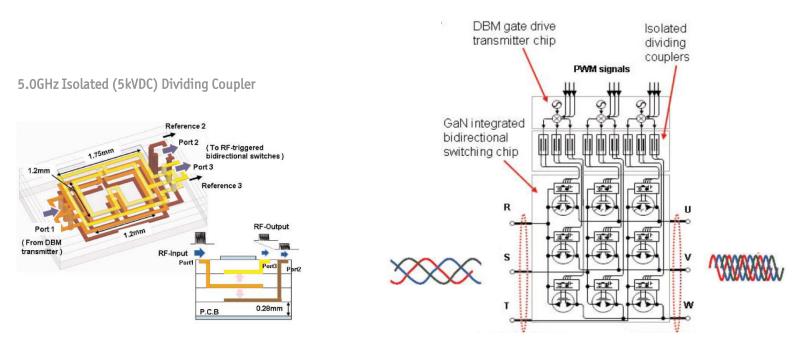




Monolithic 3D-Integration

Source: Panasonic ISSCC 2014

- GaN 3x3 Matrix Converter Chipset with Drive-By-Microwave (DBM) Technology
- 9 Dual-Gate GaN AC-Switches
- DBM Gate Drive Transmitter Chip & Isolating Couplers
- Ultra Compact $\rightarrow 25 \times 18 \text{ mm}^2$ (600V, 10A 5kW Motor)

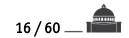




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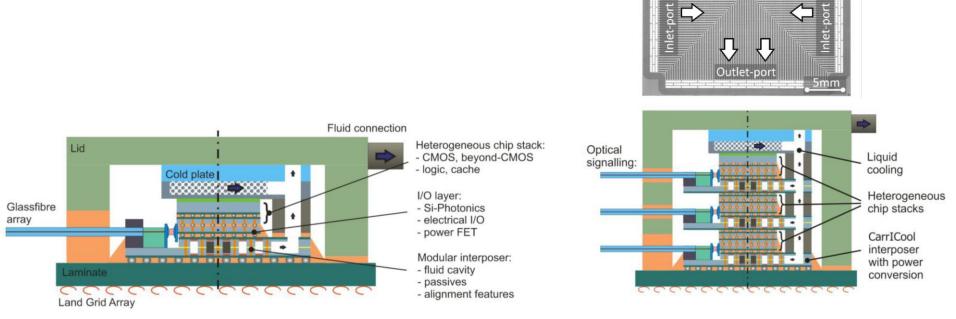


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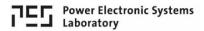
- Slowing Transistor Techn. Node Scaling → Vertical & Heterogeneous Integr. of ICs for Performance Gains
- **Extreme 3D-Integrated Cube-Sized Compute Nodes**
- Dual Side & Interlayer Microchannel Cooling



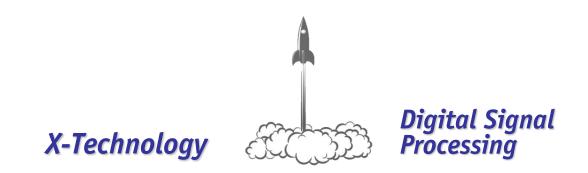
• Interposer Supporting *Optical Signaling / Volumetric Heat Removal / Power Conversion*









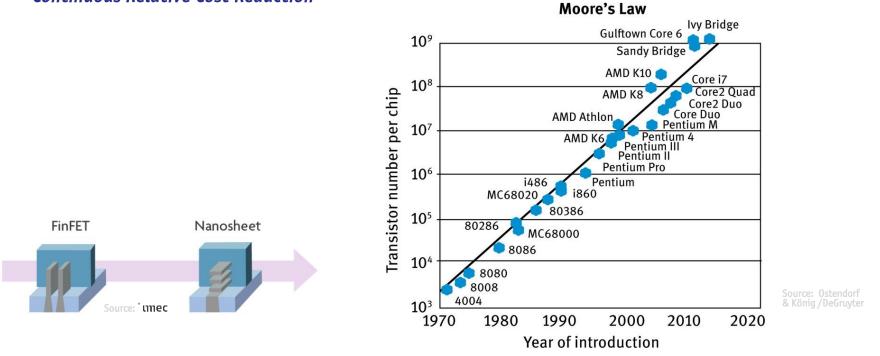






Digital Signal/Data Processing

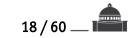
- Exponentially Improving uC / Storage Technology (!)
- Extreme Levels of Density (nm-Nodes) / Processing Speed
- Continuous Relative Cost Reduction



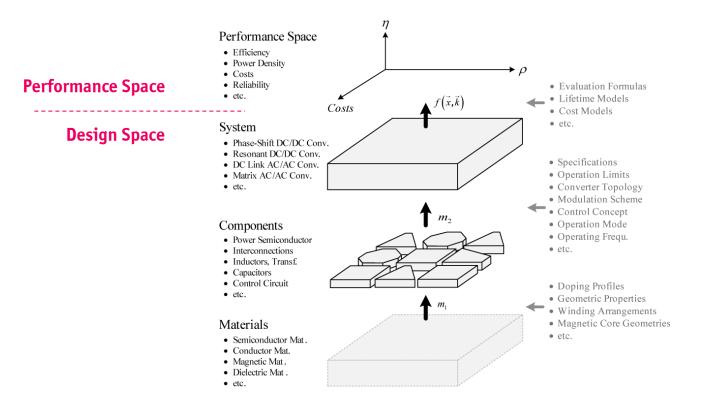
- Distributed Intelligence
- Fully Digital Control of Complex Systems AI-Based Design / Digital Twins / Industrial IoT (IIoT)







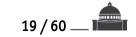
Abstraction of Power Converter Design



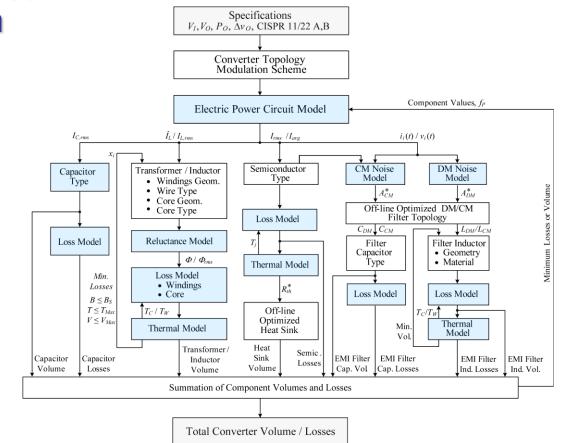
- Mapping of Design Space" into Converter "η-ρ-σ-Performance Space"
 Design Space Set of Selected Design- & Operating Parameters, Materials, Components, Topology, etc.







Multi-Objective Optimization



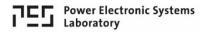


• *"Digital Twin"*

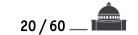
• Multi-Objective Optimization \rightarrow Best Utilization of All Degrees of Freedom (!)





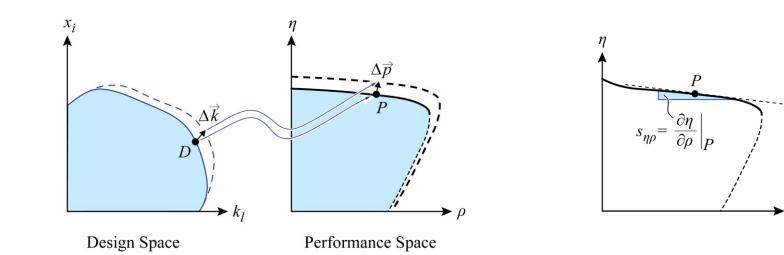






Multi-Objective Optimization

- Based on Mathematical Model of the Technology Mapping
 Multi-Objective Optimization → Best Utilization of the "Design Space"
 Identifies Absolute Performance Limits → Pareto Front / Surface

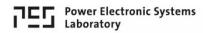


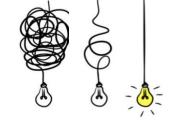
- Clarifies Sensitivity $\Delta \vec{p} / \Delta \vec{k}$ to Improvements of Technologies
- Trade-Off Analysis

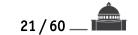


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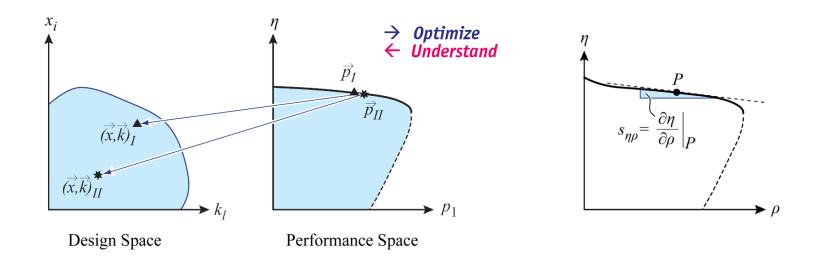






Design Space Diversity

- Equal Performance \$\vec{p}_i\$ for Largely Different Sets \$(\vec{x}, \vec{k})_i\$ of Design Parameters
 E.g. Mutual Compensation of Volume or Loss Contributions (e.g. Cond. & Sw. Losses)

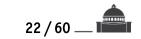


• Allows Consideration of Additional Performance Targets (e.g. Costs)



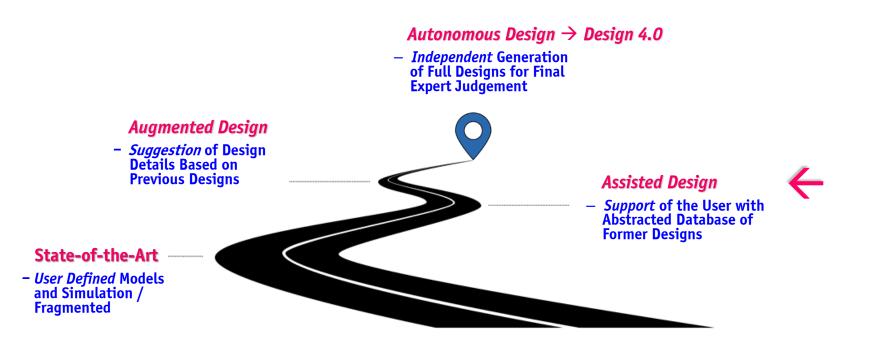


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Design Automation Roadmap

- **End-to-End Horizon** Cradle-to-Grave/Cradle Modeling & Simulation
- Design for Cost / Volume / Efficiency / Manufacturing / Testing / Reliability / Recycling



• AI-Based Summaries → No Other Way to Survive in a World of Exp. Increasing # of Publications (!)



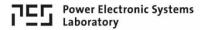


X-Concepts

Modularization Synergetic Association Functional Integration Hybridization Decentralization





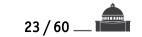






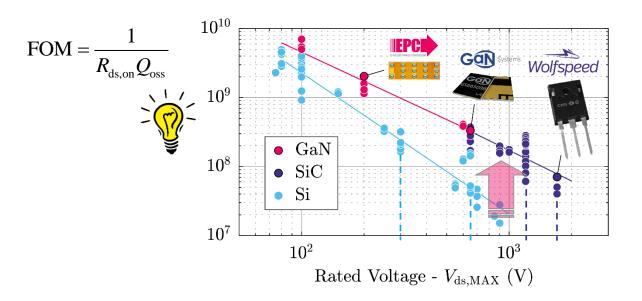






SiC/GaN Figure-of-Merit

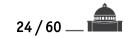
- Figure-of-Merit (FOM) Quantifies Conduction & Switching Properties FOM Determines Max. Achievable Efficiency @ Given Sw. Frequ.



Advantage of Multi-Level over 2-Level Converter Topologies





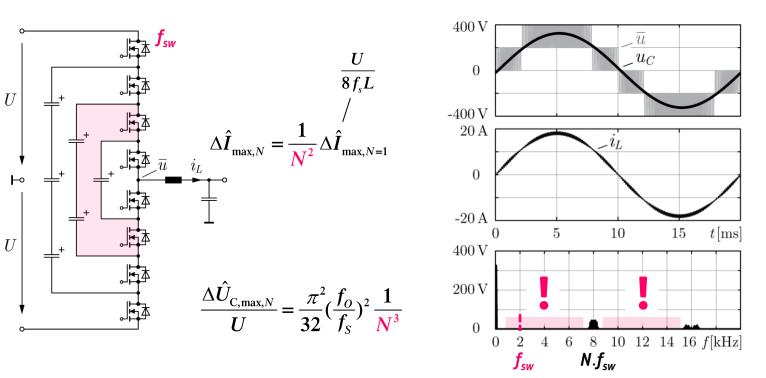


Scaling of Multi-Cell/Level Concepts

- Reduced Ripple @ Same (!) Switching Losses Lower Overall On-Resistance @ Given Blocking Voltage Application of LV Technology to HV

Source: R. Pilawa





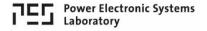
• Scalability / Manufacturability / Standardization / Redundancy





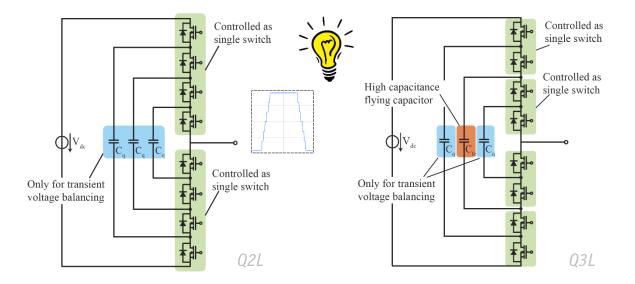
Source: M. Schweizer

ABB



Quasi-2L & Quasi-3L Inverters

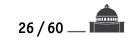
- Operation of N-Level Topology in 2-Level or 3-Level Mode
 Intermediate Voltage Levels Only Used During Sw. Transients



- Clear Partitioning of Overall Blocking Voltage & Small Flying Capacitors
 Low Voltage/Low R_{DS(on)}/Low \$ MOSFETs → High Efficiency / No Heatsinks / SMD Packages

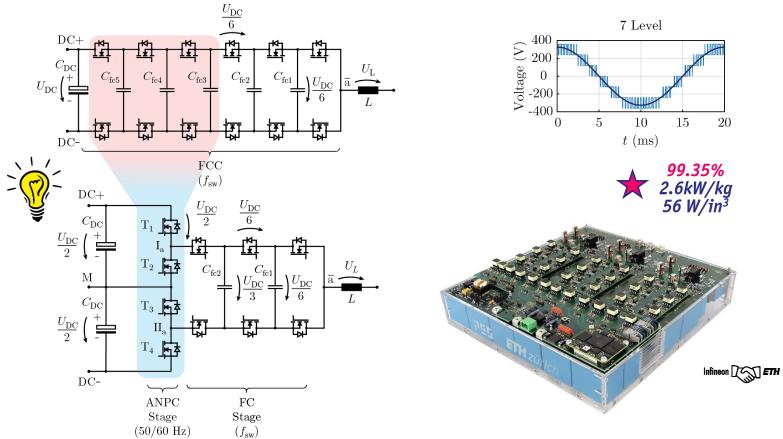






3-Φ Hybrid Multi-Level Inverter

- Realization of a 99%++ Efficient 10kW 3-Ф 400V_{rms,ll} Inverter System
 7-Level Hybrid Active NPC Topology / LV Si-Technology



• 200V Si \rightarrow 200V GaN Technology Results in 99.5% Efficiency

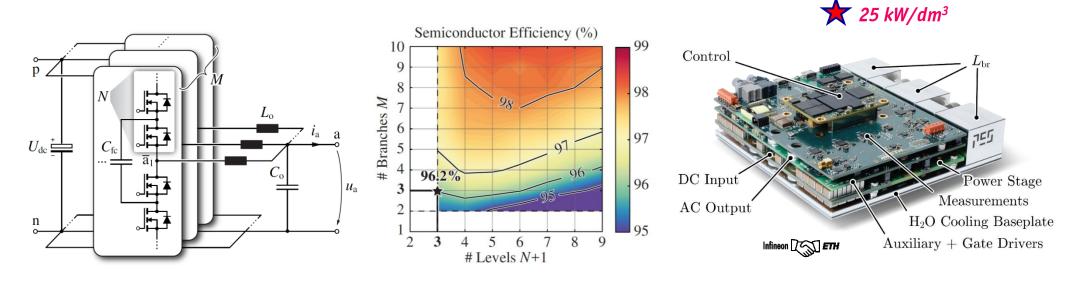






4.8MHz GaN Half-Bridge Phase Module

- Combination of Series & Parallel Interleaving
- 600V GaN Power Semiconductors, f_{sw} = 800kHz Volume of ≈180cm³ (incl. Control etc.) H₂0 Cooling Through Baseplate



• Operation @ f_{out} =100kHz / $f_{sw,eff}$ = 4.8MHz, 10kW, U_{dc} =800V

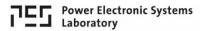




Power Electronic Systems

Laboratory

קבה

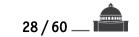






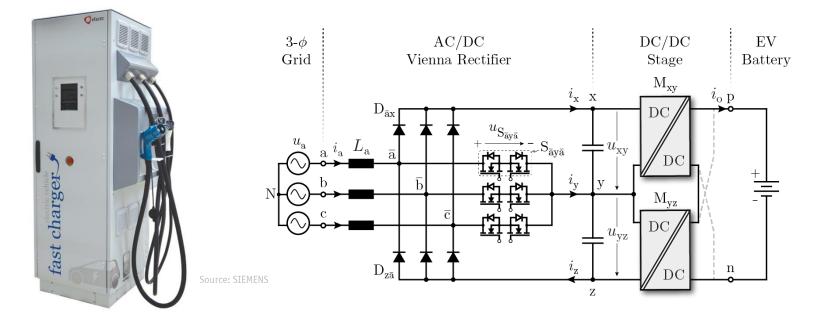






3-Φ EV-Charger Topology

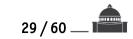
- Isolated Controlled Output Voltage
- Buck-Boost Functionality & Sinusoidal Input Current
 Applicability of 600V GaN Semiconductor Technology
 High Power Density / Low Costs



→ Conventional / Independent OR "Synergetic Control" of Input & Output Stage



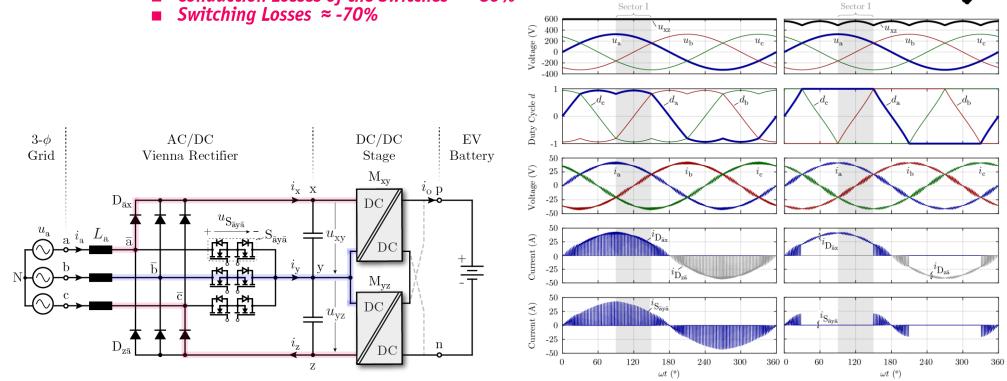




11/

Synergetic Association

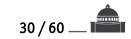
- 1/3-Modulation \rightarrow Significant Red. of Losses of the Power Switches Comp. to 3/3-PWM
- Conduction Losses of the Switches ≈ -80%



• Operating Point Dependent Selection of 1/3-PWM OR 3/3-PWM for Min. Overall Losses







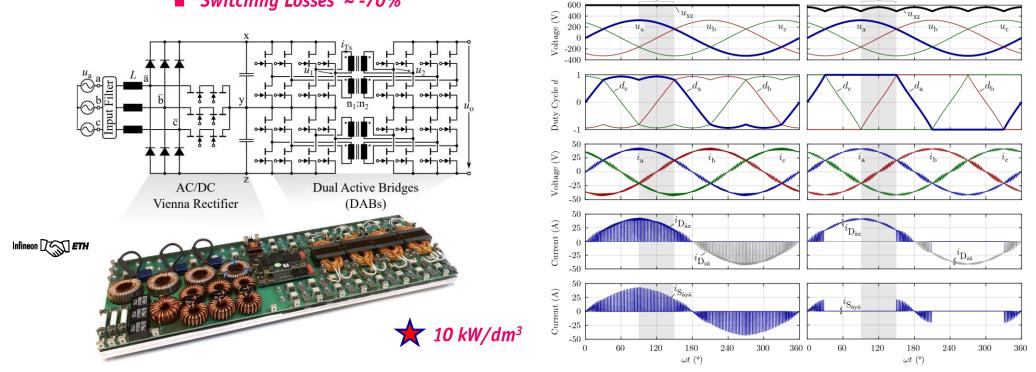
Sector I

Synergetic Association

■ 1/3-Modulation \rightarrow Significant Red. of Losses of the Power Switches Comp. to 3/3-PWM

Sector I

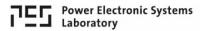
Conduction Losses of the Switches ≈ -80%
 Switching Losses ≈ -70%



• Operating Point Dependent Selection of 1/3-PWM OR 3/3-PWM for Min. Overall Losses









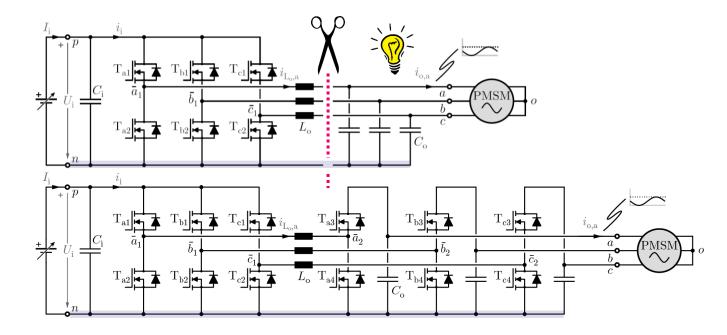






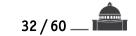
Buck-Boost 3- Variable Speed Drive Inverter

- Generation of AC-Voltages Using Unipolar Bridge-Legs
- Utilize Filter Inductor for Boost Operation \rightarrow Functional Integration



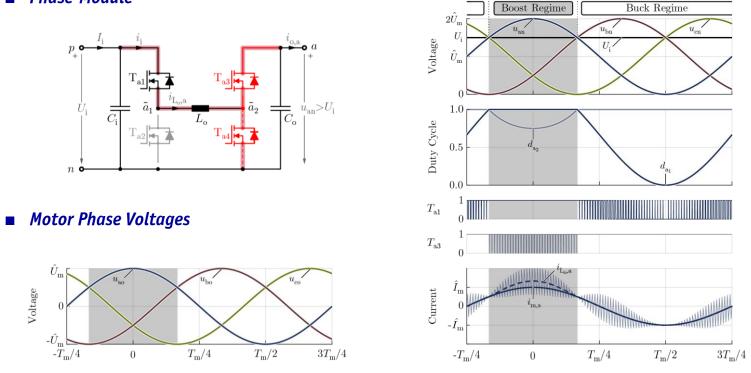
Switch-Mode Operation of Buck OR Boost Stage → Single-Stage Energy Conversion (!)
 3-Φ Continuous Sinusoidal Output / Low EMI → No Shielded Cables / No Motor Insul. Stress





Boost-Operation $u_{an} > U_i$

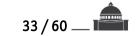
Phase-Module



 φ_{o}

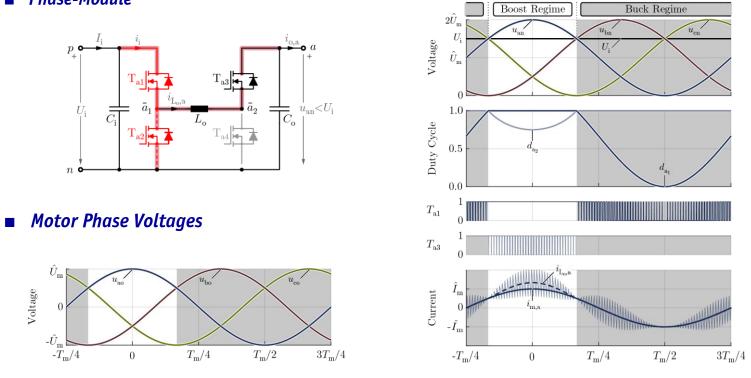
- Current-Source-Type Operation
 Clamping of Buck-Bridge High-Side Switch → Quasi Single-Stage Energy Conversion





Buck-Operation $u_{an} < U_i$

Phase-Module



 $\varphi_{\rm o}$

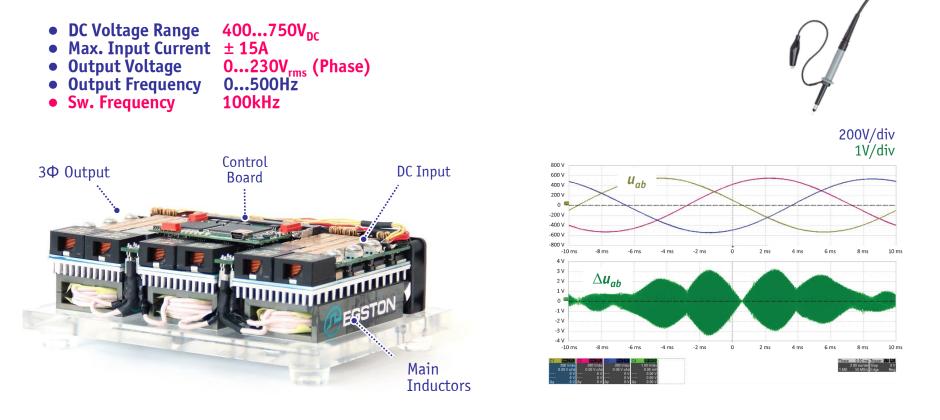
 $-\varphi_{\rm o}$

- Voltage-Source-Type Operation
 Clamping of Boost-Bridge High-Side Switch → Quasi Single-Stage Energy Conversion





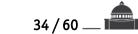


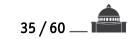


Dimensions \rightarrow 160 x 110 x 42 mm³





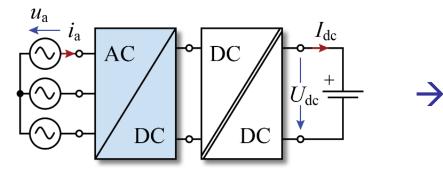


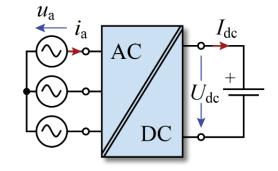


Isolated 3- Φ **AC/DC Converters**

- **Conventional Approach** \rightarrow Two-Stage | 3- \oplus PFC Rectifier & DC/DC Converter Stage
 - **Functional Integration** \rightarrow Utilizes AC/DC-Stage for Power Factor Corr. & HF AC Voltage Generation
 - \rightarrow Transformer Stray Inductance Used as Current Source







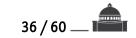
320...530V_{rms} Line-to-Line

380 V_{DC} (260...400 V_{DC}) Datacenter Power Distribution

- Elimination of DC/DC Converter Input Stage & DC-Link \rightarrow Single-Stage Energy Conversion (!)
- Electric Vehicle Battery Charging | Datacenter Power Supply | AC Grid Interfaces of DC Micro-Grids

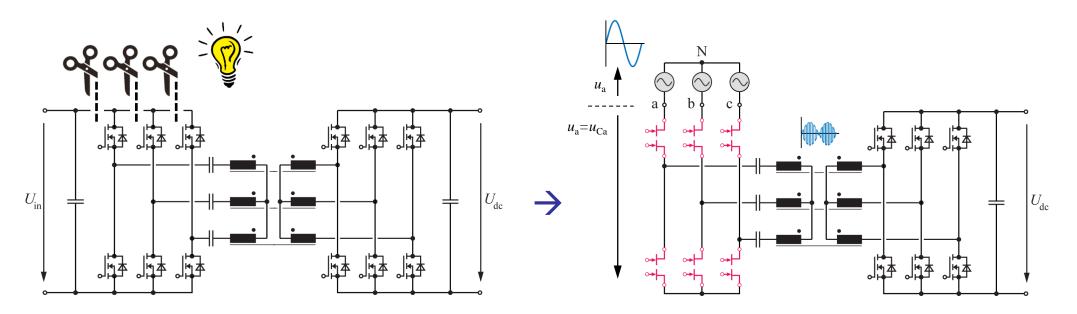






3-O Input DAB-Type AC/DC Converter (1)

Modification of 3-Φ Xfrm DAB → Prim.-Side Phase-Modular AC/DC Converter Topology
 Synchronized (!) Prim.-Side Switching @ 50% Duty Cycle

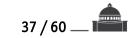


Voltage Stress on Prim.-Side AC Switches Determined by Peak Value of Grid PHASE Voltage (!)

Bidirectional Power Flow

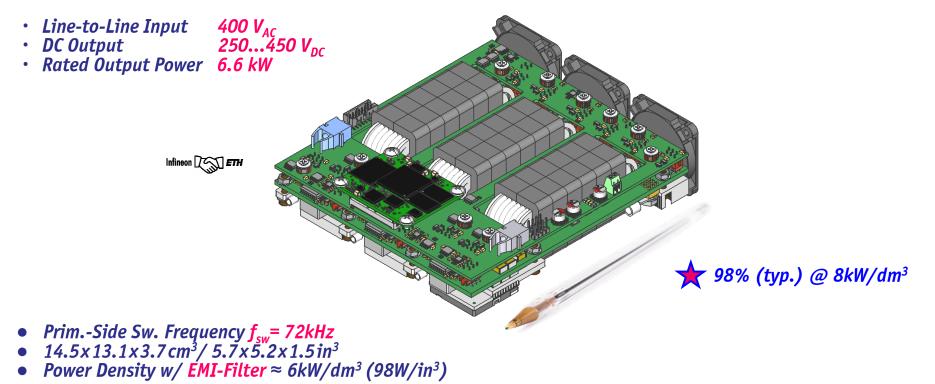






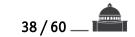
3-••Input DAB-Type AC/DC Converter (2)

- Voltage Stress on AC-Side Power Transistors Determined by PHASE Voltage Amplitude (!)
- 600V GaN MBDS for 400V RMS Line-to-Line Grid ($U_{L-L,pk} = 560V$) Unity Power Factor / Bidirectional





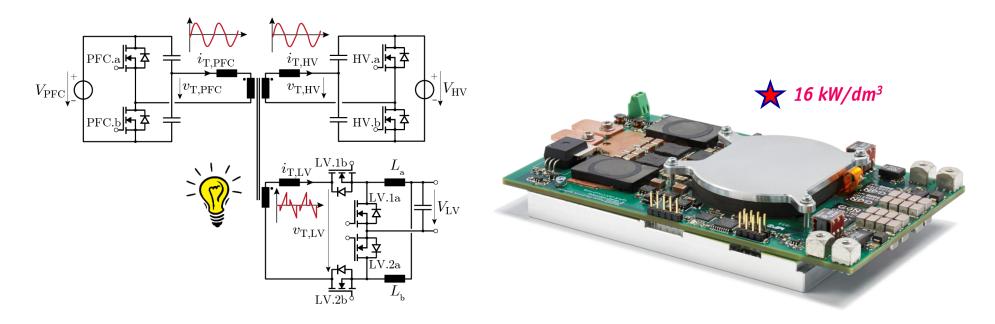




3-Port Resonant GaN DC/DC Converter

- Single Transformer & Decoupled Power Flow Control
- Charge Mode PFC \rightarrow HV (250...500V) SRC DCX / Const. f_{sw} , Min. Series Inductance / ZVS Drive Mode HV \rightarrow LV (10.5...15V) 2 Interleaved Buck-Converters / Var. f_{sw} / ZVS

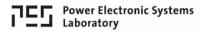
P = 3.6*k*W



- Peak Efficiency of 96.5% in Charge Mode / 95.5% in Drive Mode
- **PCB-Based Windings** / No Litz Wire Windings \rightarrow Fully Automated Manufacturing





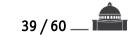






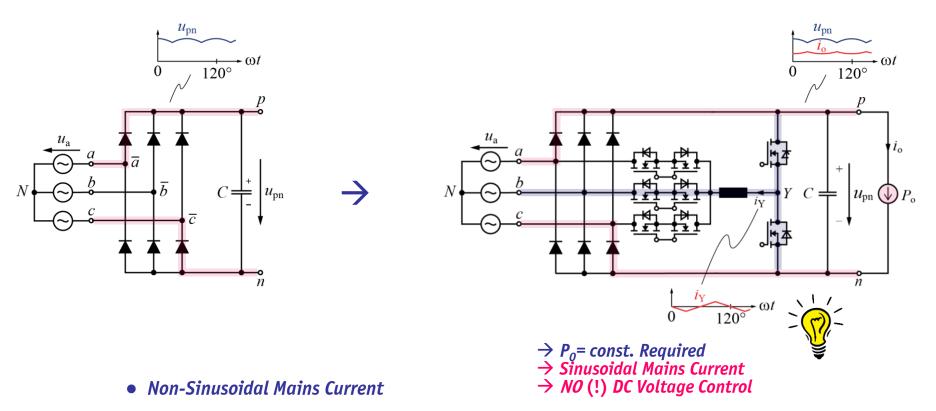


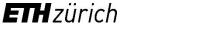




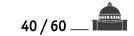
Hybrid Integrated Active Filter (IAF) PFC Rectifier

- Hybrid Combination of Mains- and Forced-Commutated Converter 3rd Harmonic Current Injection into Phase with Lowest Voltage Phase Selector AC Switches Operated @ Mains Frequency 3-Φ Unfolder



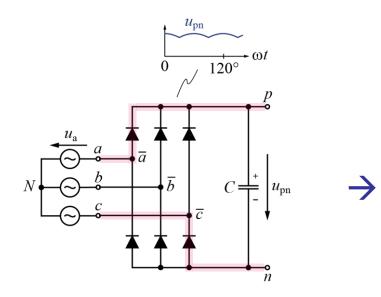


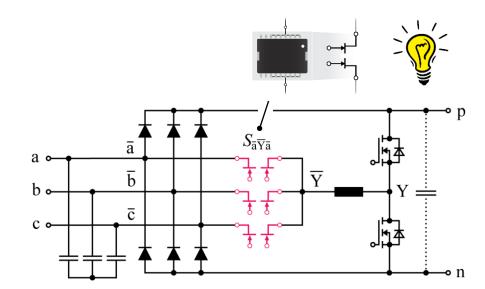




Hybrid Integrated Active Filter (IAF) PFC Rectifier

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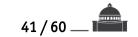


Non-Sinusoidal Mains Current

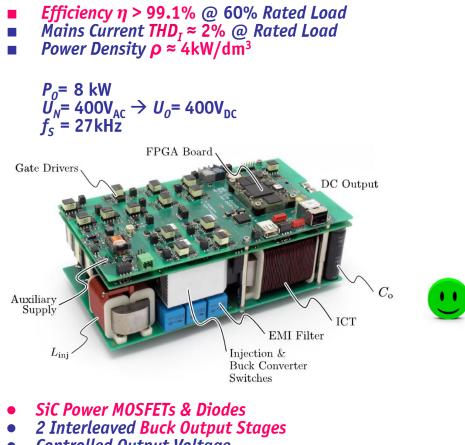
 \rightarrow P₀= const. Required \rightarrow Sinusoidal Mains Current \rightarrow NO (!) DC Voltage Control



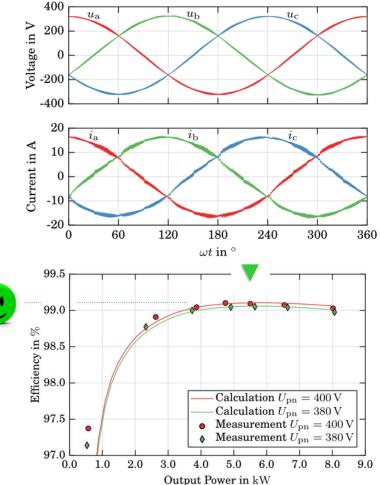




IAF PFC Rectifier & Buck Converter Demonstrator



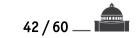
• Controlled Output Voltage



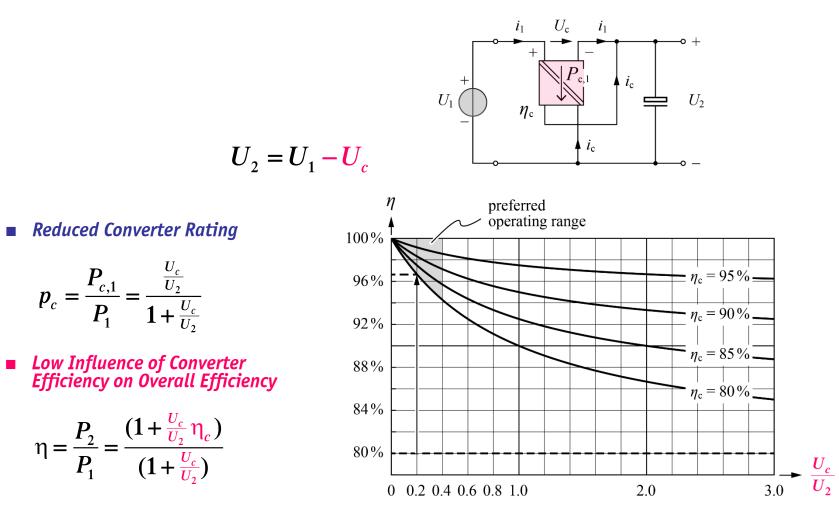


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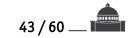


Partial/Differential Power Processing



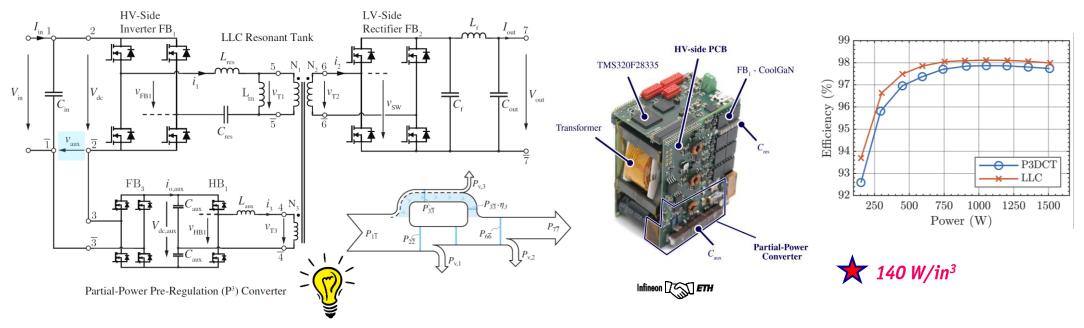






Partial-Power Pre-Regulated LLC DC-Transformer

- Aux. Converter Stage for ± 10% V_{in} Compensation | V_{in} = 340V ... 420V
 Const. Voltage Transfer Ratio / High Efficiency LLC «DC/DC Transformer» @ Const. Frequency | f_{sw} = 100kHz
 Const. Output Voltage | V_{out} = 48V

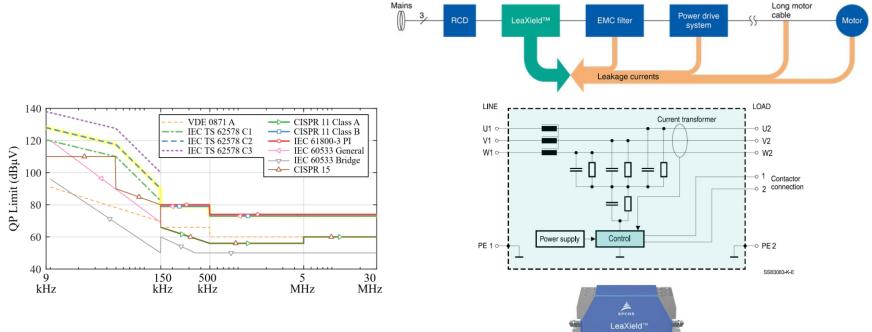


- **Rectangular Aux. Voltage Added or Subtracted (f**_{aux} = 600kHz) from V_{in} Marginal Impact of Control on Overall Power Density & Efficiency



Hybrid EMI-Filter / Leakage Current Reduction

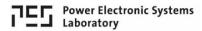
- **Future Extension of EMI Limits** 9kHz ... 150kHz | IEC TS 62578 Tech Spec. for Active Infeed Conv. Applications
- Earth Leakage Current "Compensation"
- Conducted CM EMI-Filter



- Prevents Unintentional Residual Current Device (RCD) Tripping w/o Isolation Transformer
- Attenuation of Cond. EMI Emissions in Wide Frequency Range 30/40/15dB @ 4/10/150kHz





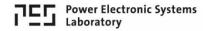


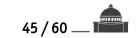






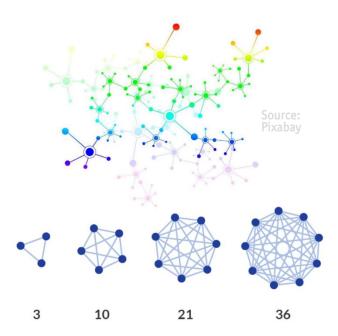


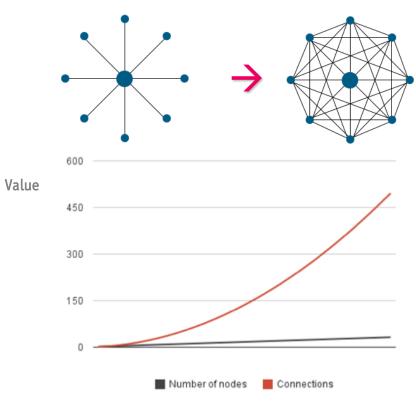




Networking Scaling

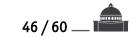
- Metcalfe's Law
- Moving from Hub-Based Concept to Community Concept Increases Potential Network Value Over-Proportional $\rightarrow \sim n(n-1)$ or $\sim n \log(n)$





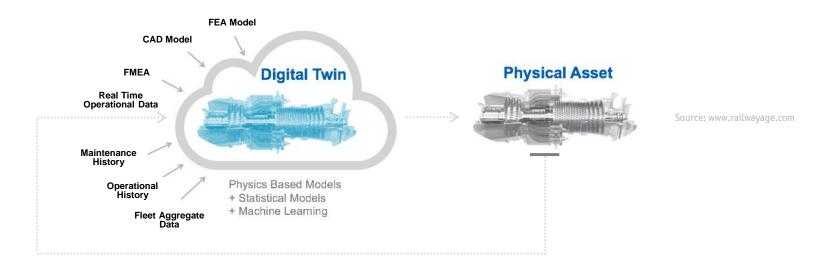






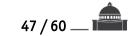
IIoT in Power Electronics

Digital Twin → Physics-Based "Digital Mirror Image" **Digital Thread** \rightarrow "Weaving" Real/Physical & Virtual World Together



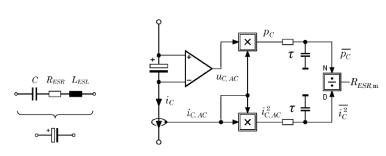
- Requires Proper Interfaces for Models & Automated Design
 Model of System's Past/Current/Future State → Design Corrections / Predictive Maintenance etc.

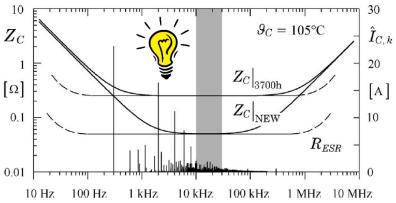




IIoT Starts with Sensors (!)

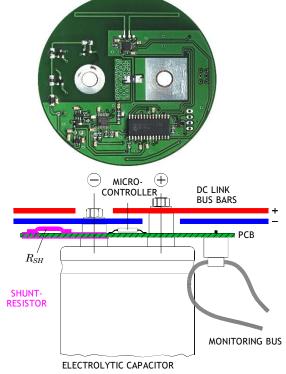
- **Condition Monitoring of DC Link Capacitors** On-Line Measurement of the ESR in *"Frequency Window"* (Temp. Compensated) Data Transfer by Optical Fibre or Near-Field RF-Link





Possible Integration into Capacitor Housing or PCB

Additionally features Series Connect. Voltage Balancing

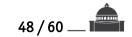






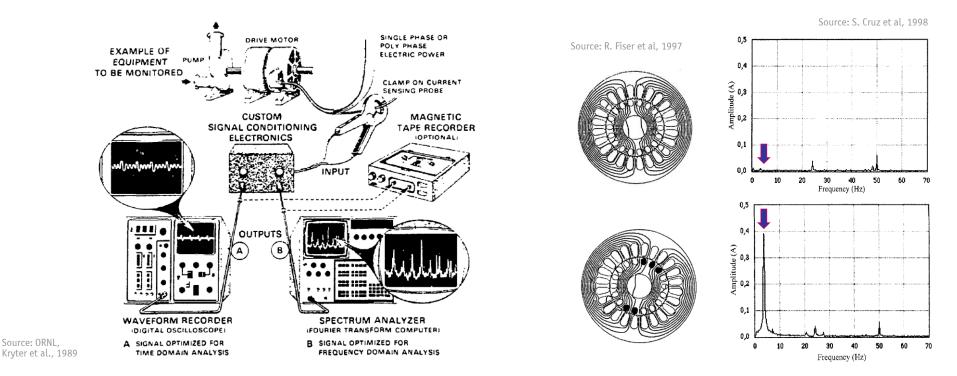






Motor Condition Monitoring / Fault Detection

- Utilize the "Motor as Transducer" for Determining Aging / Wear of Motor and/or Mechanical Load
 Non-Intrusive Detection of Mechanical or Electrical Bearings or Stator & Rotor Abnormalities
 Motor Current Signature Analysis (MCSA) in Time & Frequency Domain

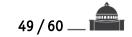


ORNL (1989) — MCSA Condition Monitoring of Motor-Valves in Nuclear Power Plant Safety Systems

• ANNs Discussed for Diagnostics since 25+ Years — Improvements w/ Computing Power of Modern Inverters

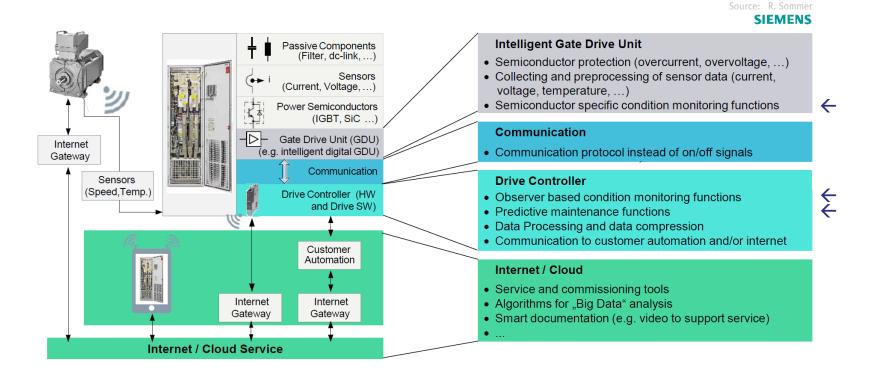






Smart Inverter Concept

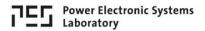
Utilize High Computing Power and Network Effects in the Cloud



• On-Line Protection / Monitoring / Optimization on Component | Converter | Drive | Application Level





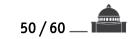






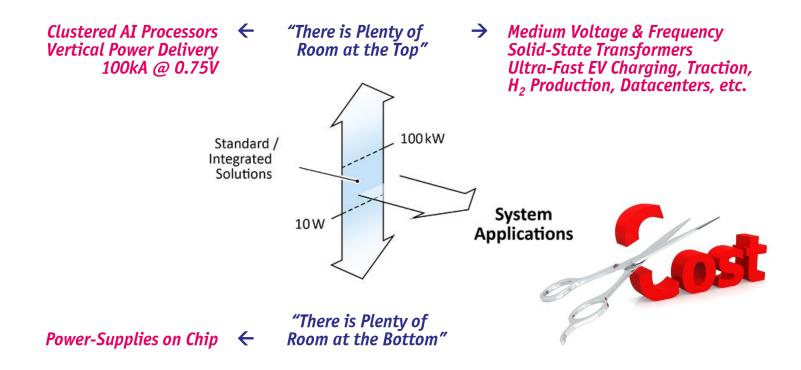






Future Application Areas

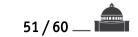
- WBG Driven Extension to Medium Voltage | Extension to Micro-Power Electronics
- Extreme Cost Pressure for Standardized Solutions (!)



- "There's Plenty of Room at the Bottom", Lecture by R. Feynman @ Caltech, 1959
- Key Importance of Technology Partnerships of Academia & Industry

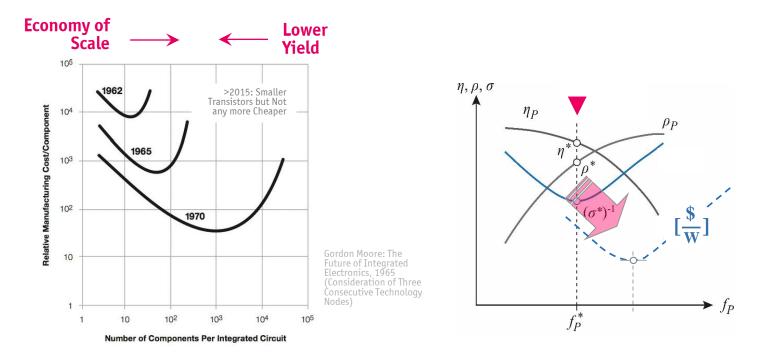






"Moore's Law" of Power Electronics

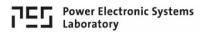
- "Moore's Law" Defines Consecutive Technology Nodes Based on Min. Costs per Integr. Circuit (!)
- Complexity @ Min. Comp. Costs Increases approx. by Factor of 2 / Year



- Potential Power Density Improvement Factor 2... 5 Until 2030
- Definition of " $\eta^*, \rho^*, \sigma^*, f_{\rho}^*$ Technology Node" Must Consider Conv. Type / Operating Range etc. (!)









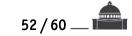
Source: www.roadtrafficsigns.com











Power Electronics \rightarrow **Electronic** "Energy" Management

Design Considering Converters as Standardized "Integrated Circuits" (PEBBs)

Extend Analysis to Converter Clusters / Power Supply Chains / etc.



- "Converter" "Time"
- "Power"

→ "Systems" (Microgrid) or "Hybrid Systems" (Automation / Aircraft)
 → "Integral over Time"
 → "Energy"

$$p(t) \rightarrow \int_{0}^{t} p(t) dt$$

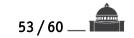
- Power Conversion \rightarrow Energy Management / Distribution
- → System Analysis (incl. Interactions Conv. / Conv. or Load or Mains)
 → System Stability (Autonom. Cntrl of Distributed Converters) — Converter Analysis
- Converter Stability
 - \rightarrow Energy Storage & Demand Side Management \rightarrow Life Cycle Costs / Mission Efficiency / Supply Chain Efficiency
- Costs / Efficiencv

- Cap. Filtering

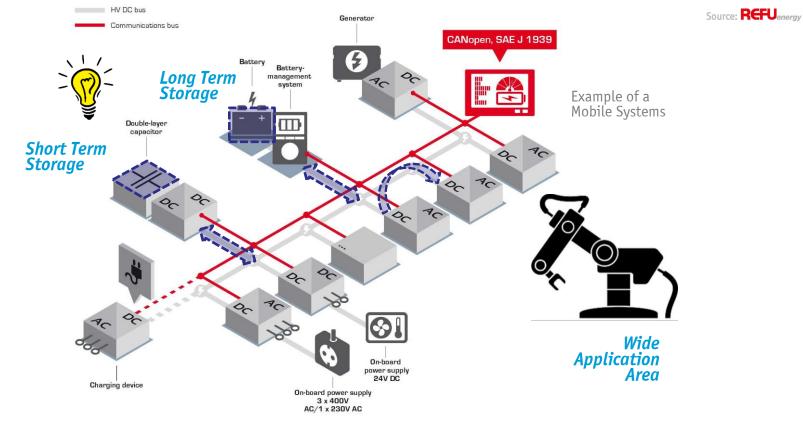
- etc.







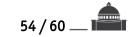
Energy Management — *DC Micro-/Nanogrids*



- **Renewable Energy Integration**
- "Networked" Bidir. Flow/Exchange of Energy & Signals/Data | Distrib. Autonom. Cntrl & Protect.
 Hybrid Power Solutions Combin. of Electric / Hydraulic / etc. Systems | Continuous Opt. & Diagnosis

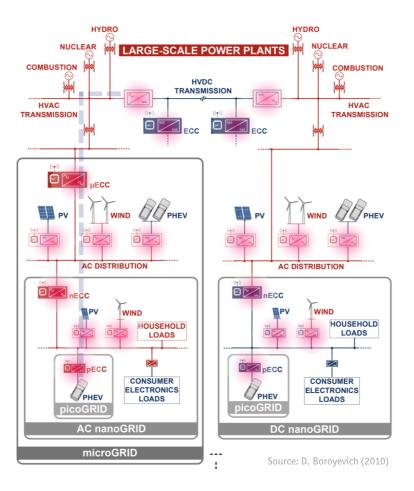




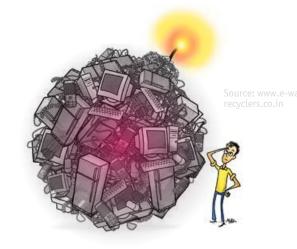


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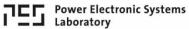
- **25'000 GW** Installed Ren. Generation in 2050
- **15'000 GWh** Batt. Storage
- 4x Power Electr. Conversion btw Generation & Load
- 100'000 GW of Installed Converter Power
- **20 Years** of Useful Life



5'000 GW_{eq} = 5'000'000'000 kW_{eq} of E-Waste / Year (!)
 10'000'000'000 \$ of Potential Value









■ 52'000'000 Tons of Electronic Waste Produced Worldwide in 2021 → 74'000'000 Tons in 2030

• Increasingly Complex Constructions \rightarrow No Repair or Recycling

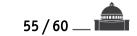




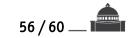
• Growing Global E-Waste Streams \rightarrow Regulations Mandatory (!)







Source:



* Considered critical minerals

The Paradigm Shift (1)

Growing Global E-Waste Streams / < 20% Recycled 120'000'000 Tons of Global E-Waste in 2050



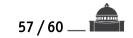
Iron

Copper

- "Linear" Economy / Take-Make-Dispose → "Circular" Economy / Perpetual Flow of Resources Resources Returned into the Product Cycle at the End of Use E-Waste Represents an "Urban Mine" w/ Great Economic Potential



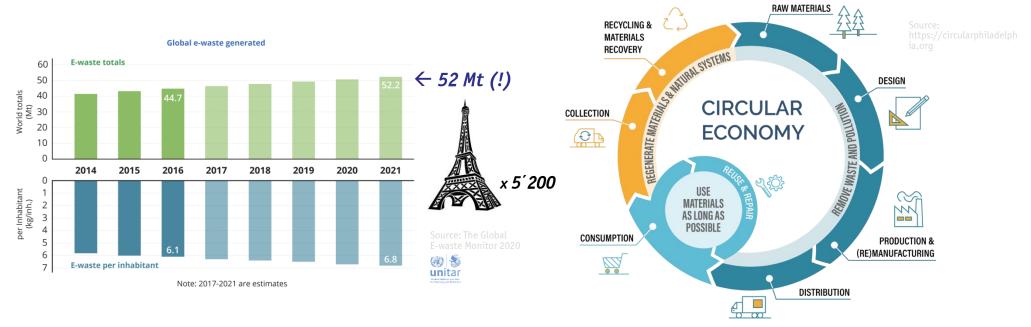




The Paradigm Shift (2)

Growing Global E-Waste Streams / < 20% Recycled

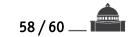
120´000´000 Tons of Global E-Waste in 2050



- *"Linear" Economy / Take-Make-Dispose* \rightarrow *"Circular" Economy / Perpetual Flow of Resources Resources Returned into the Product Cycle at the End of Use*

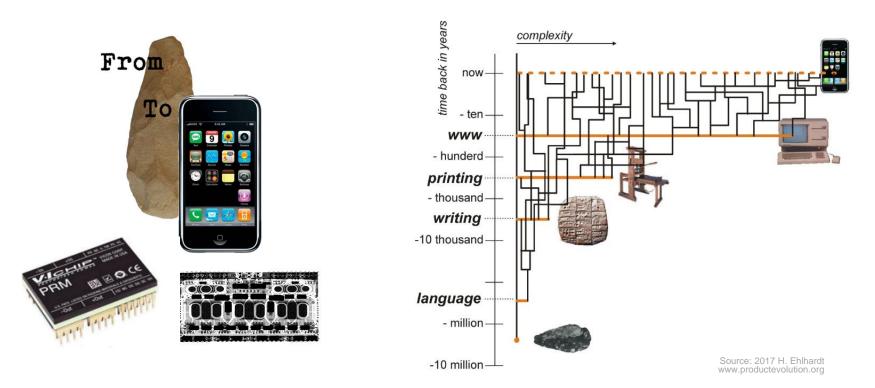






Complexity Challenge

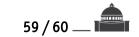
- **Technological Innovation Increasing Level of Complexity & Diversity of Modern Products**
- Exp. Accelerating Technological Advancement (R. Kurzweil)



Ultra-Compact Systems / Functional Integration — Main Obstacle for Material Separation

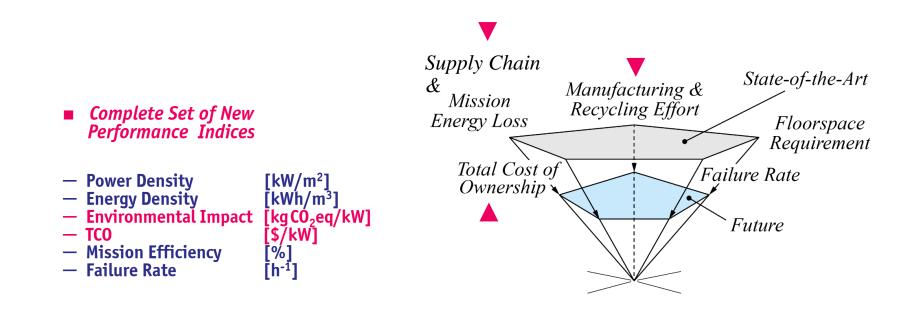






Performance Indicators / Trends

Energy Systems / Electronics



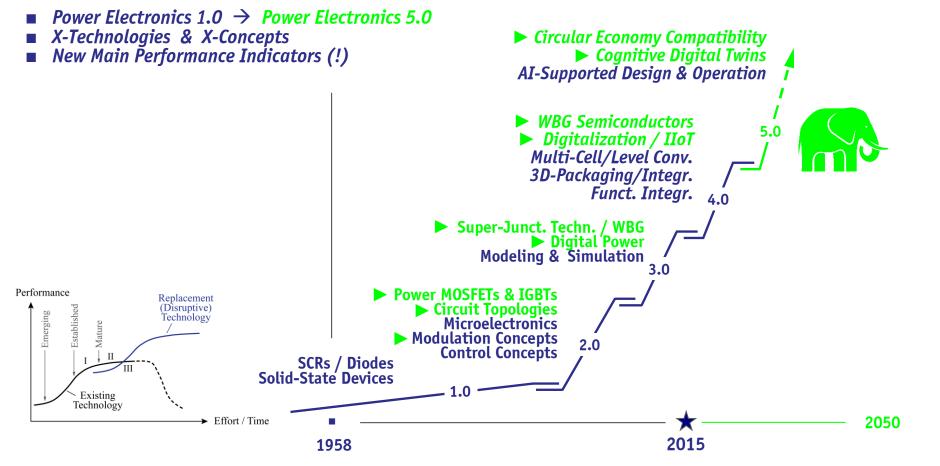


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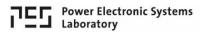
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Power Electronics 5.0









Thank you!



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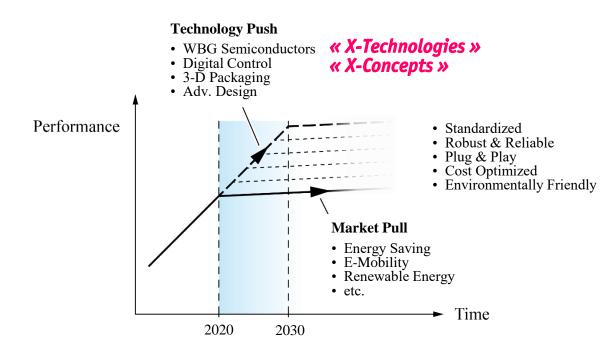






Future Development / Trends

- MEGA-Trends Renewable Energy / Energy Saving / E-Mobility / "SMART XXX"
- Power Electronics will Massively Spread in Highly Diverse Applications



- More Application Specific Solutions
- More Specific Requirements High Peak/Avg. Ratio, Wide Volt. Range etc.
- Cost Optimization @ Given Performance Level for Standard Solutions
- Design / Optimize / Verify (All in Simulation) Faster / Cheaper / Better

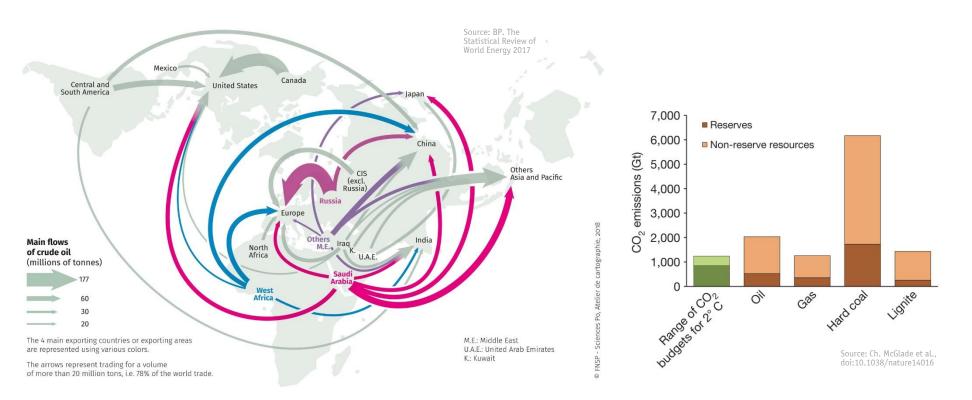






Energy Independence / Security of Supply

■ Global Oil Trade (2016) — High Import Dependency of Leading Economies



2°C Target → Globally, 30% of Oil Reserves | 50% Gas Reserves | > 80% Coal Reserves Should Remain Unused (!)
 "The Stone Age Didn't End for Lack of Stone — The Oil Age will End Long Before the World Runs Out of Oil"

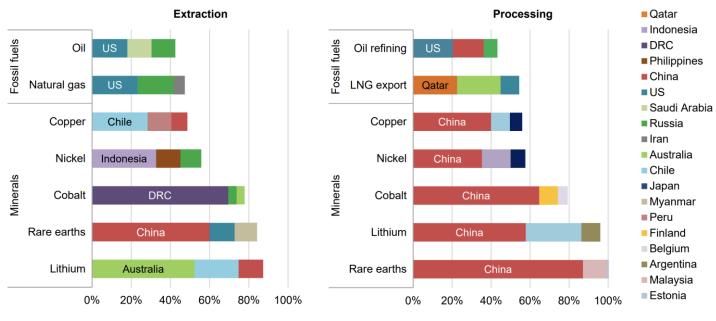






Critical Minerals

Production of Selected Minerals Critical for the Clean Energy Transition



Shares of top three producing countries, 2019

Extraction & Processing More Geographically Concentrated than for Oil & Nat. Gas (!)

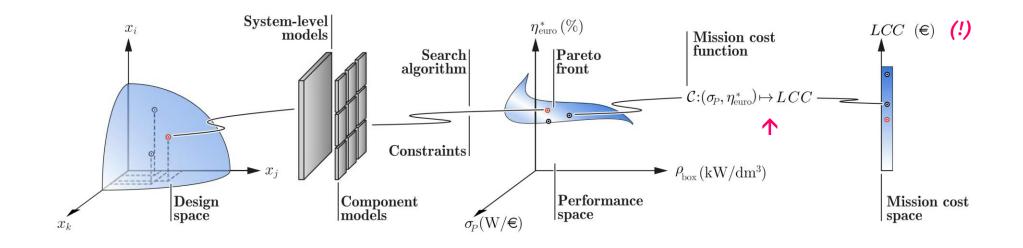






Multi-Objective Optimization

Typ. Performance Indices — Efficiency η [%] | Power Density ρ [kW/dm³] | Rel. Cost σ [kW/\$]
 Consideration of Specific Operating Points OR Mission Profile



• Mission Profile — Power Loss \rightarrow Energy Loss / Life-Cycle Cost (!)

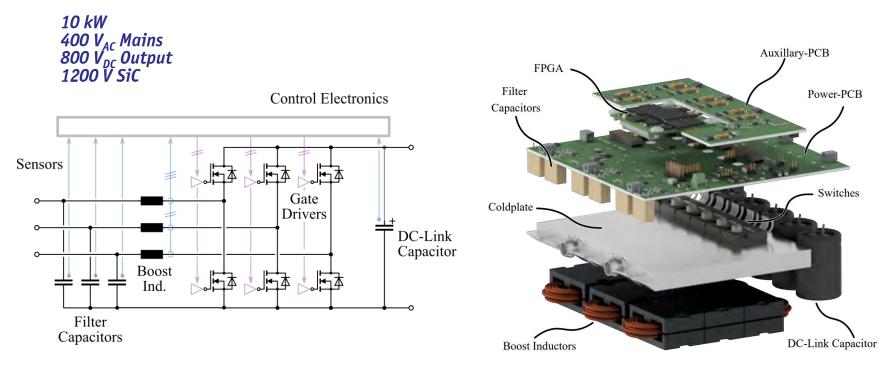


ETH zürich



Example — Three-Phase AC/DC PEBB

Key Power Electronics Building Block (PEBB) for Three-Phase PFC Rectifiers & Inverters



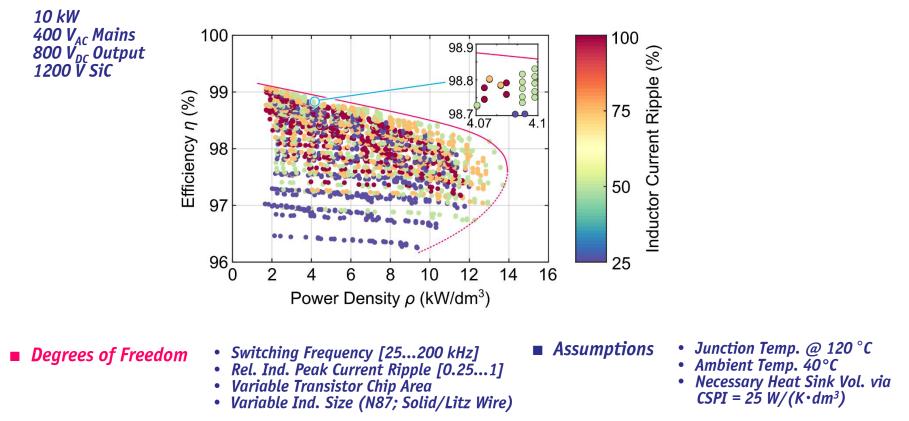
- Main Components Considered (Losses, Volume, CO_{2eq}) Power Trans., Heat Sink, Boost Ind., DC-Link Cap., Filter Cap., Gate Drivers, Sensors, Contr. Electr., PCBs





η - ρ -Multi-Objective Optimization

- Design Space Diversity Optimiz. for Min. Environmental Impact w/o Compromising Eff. or Power Density (!)
- Example of a Three-Phase Two-Level AC-DC PEBB w/ LC-Input Filter

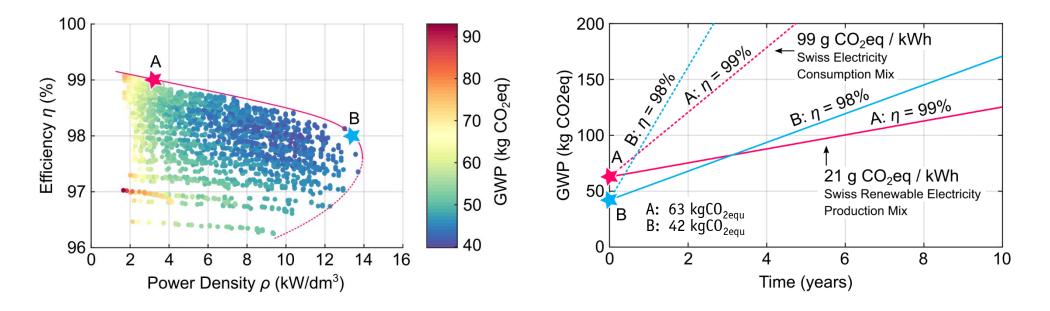






Efficiency vs. Operating Time Carbon Footprint

- **Global Warming Potential GWP [kg CO_{2eq}] as Add. Performance Indicator** Mission Matters Example 8 Hours Full Load per Day Over 10 Years
- Electricity Mix Matters Carbon Intensity



Energy Losses During Use Phase Contribute to Overall GWP

• More Eff. Designs w/ Higher Initial GWP Outperform Less Eff. Designs for Longer Operating Times



Power Elect Laboratory

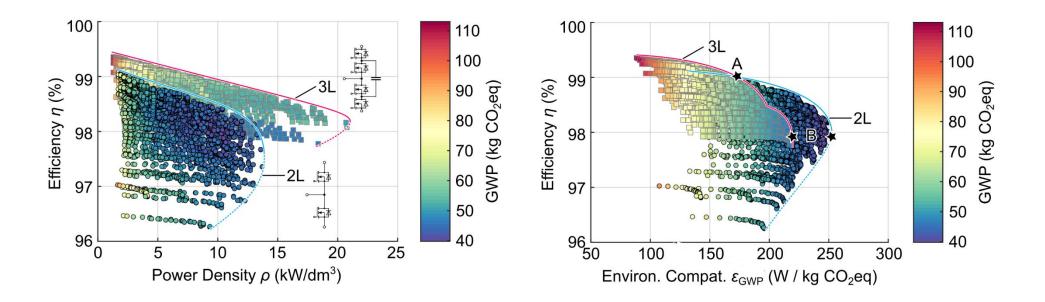
Power Electronic Systems





2-Level vs. 3-Level PEBB Evaluation

3-Level Flying-Capacitor Bridge-Legs w/ 650 V SiC MOSFETS / 2-Level Bridge-Legs w/ 1200 V SiC MOSFETs
 400 V_{AC} Mains | 800 V_{DC} | 10 kW | LC-Filter w/ Same Capacitor Voltage Ripple



■ Higher 3L Inverter Eff. & Power Density BUT Lower Environm. Compatibility [W/kgCO_{2ea}]

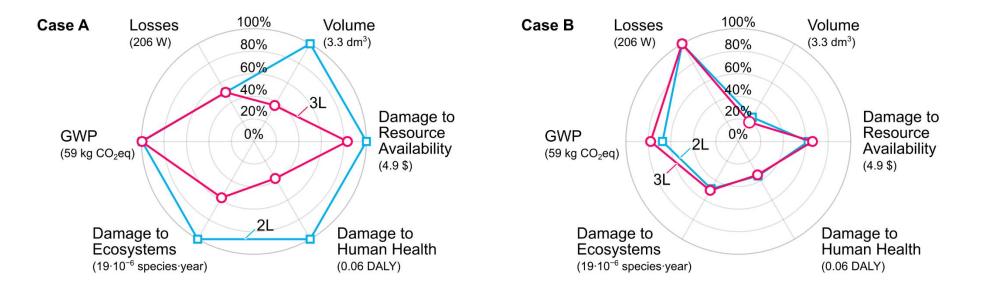
Higher 3L Initial GWP Due to Higher # of Power Semiconductors





Comprehensive Environmental Impact Profile

- Further Environm. Impact Indicators Volume & ReCiPe 2016 Areas of Protection
- Human Health | Ecosyst. Quality | Resource Scarcity Comparative Evaluation of 2L vs. 3L PEBB



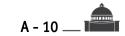
Case A 99% Eff. @ Equal GWP — Significantly Diff. Volumes & Diff. ReCiPe Performance
 Case B 98% Eff. @ Highest Rel. Environm. Compatibility — Similar Volumes & Environm. Impacts



Power Electronic Systems

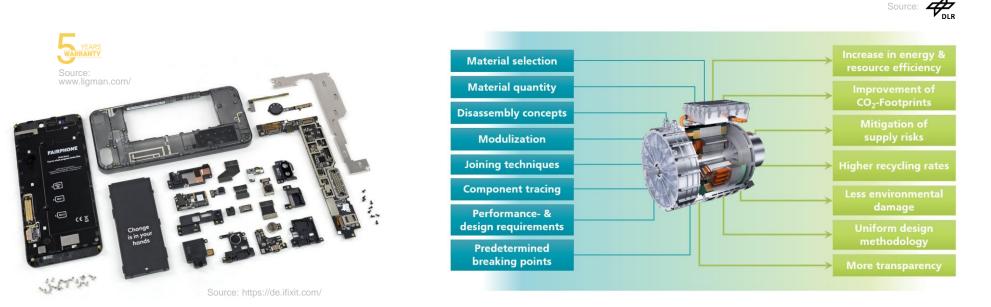
Laboratory





Design for Repairability & Circularity

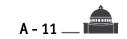
- **Eco-Design** Reduce Environmental Impact of Products, incl. Energy Consumption Over Life Cycle
- Re-Pair / Re-Use / Disassembly / Sorting & Max. Material Recovery, etc. Considered
- EU Eco-Design Guidelines (!)

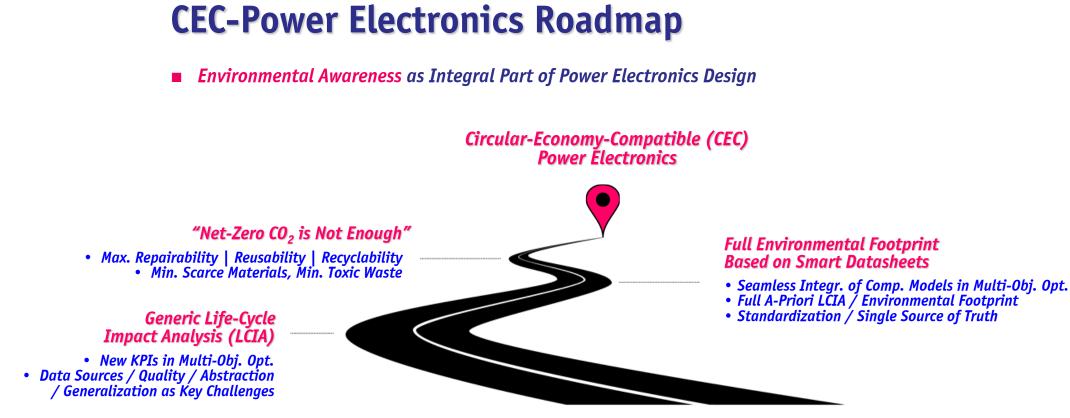


- FAIRPHONE Modular Design | Man. Replaceable Parts | 100% Recycl. of Sold Products | Fairtrade Materials
 80% of Sustainability / Environmental Impact of Products are Locked-In at the Design Phase







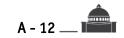


Classical ηρ-**Pareto Optimization / Design** • Manual A-Posteriori LCA of Complete Converters

Automated Design | On-Line Monitoring | Prev. Maintenance | Digital Product Passport



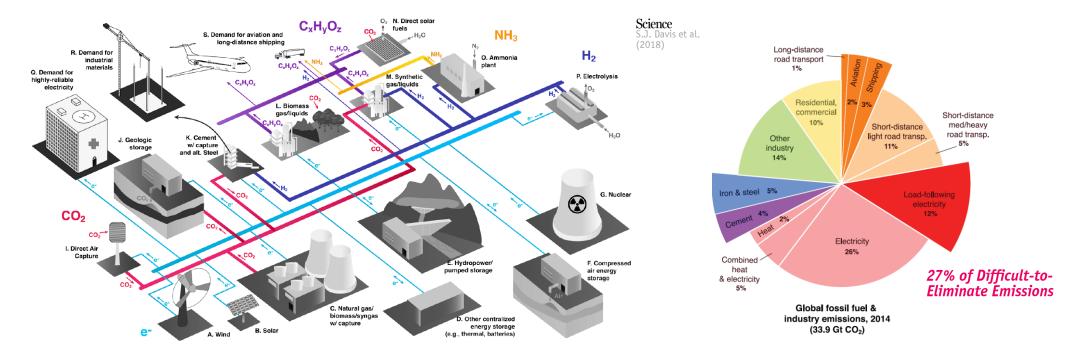




The Comprehensive Solution (!)

CO₂-Free Electricity / Electrification — Viable Pathway for Reducing Emissions !&! Costs (Long Term)

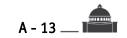
E-Fuels & P2X for Long-Haul Transport / Aviation / etc. & Short Term / Seasonal Storage



Integrated Net-Zero Multi-Carrier Energy System — E-Energy | Heat & Cold (N.N.) | etc. | Storage | CO₂C&S Missing Multi-Discipl. Research on Cross-Sector Converters / Technologies / Geogr. Diversity / Economics etc.

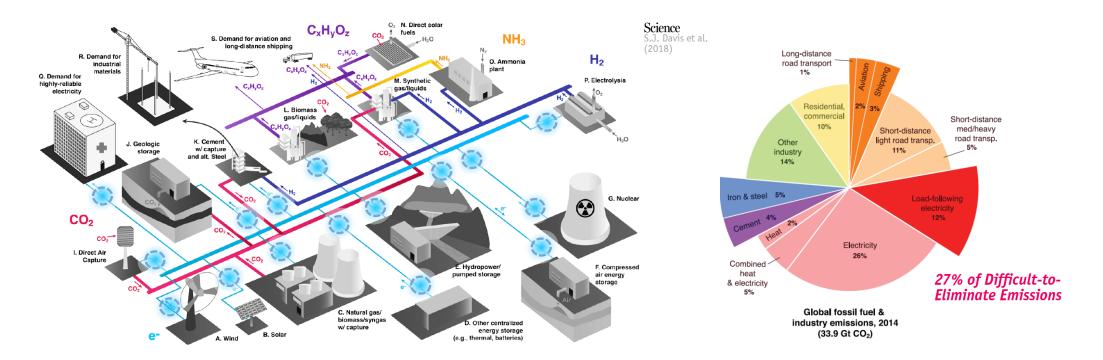






The Comprehensive Solution (!)

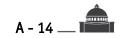
Power Electronics (A Key Enabler !



Ren. Gen. & Cross-Sector Conv. — Heat-Pumps / Electrolyzers / FCs / etc. \rightarrow All Power Electronics Dependent !









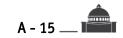
- **2 Billion People** are Lacking Access to Clean Energy Urgent Need for Rural Electrification



2 US\$ / Household / Month (!) for 2 LED Lights & Mobile-Phone Charging

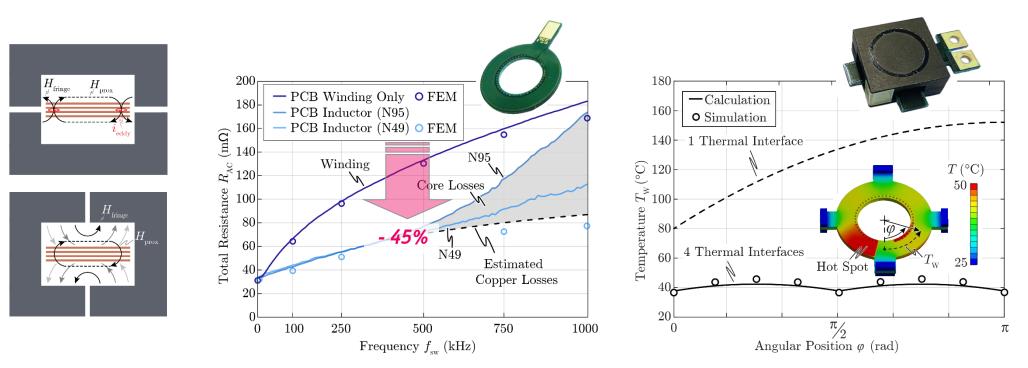






Low-Loss PCB-Winding Inductor

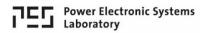
- Conv. PCB Windings & Airgaps \rightarrow Skin / Proximity / Fringing Field $^{\perp}$ to PCB \rightarrow Current Displacement Arrangement of Airgaps for Mutual Field Compensation Thermal Interfaces for Efficient Cooling



- Optimal Positions & Wdg Distance of Airgaps for Multi-Airgap / Multi-Layer Inductors
- Factor of 3 Red. of Skin & Prox. Losses









The End



